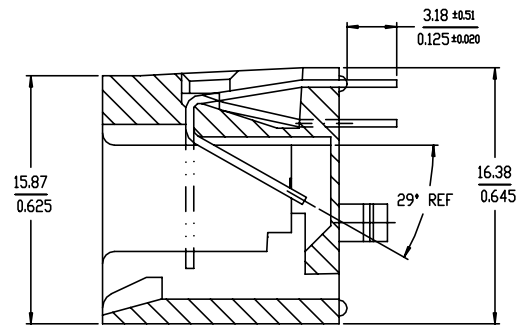
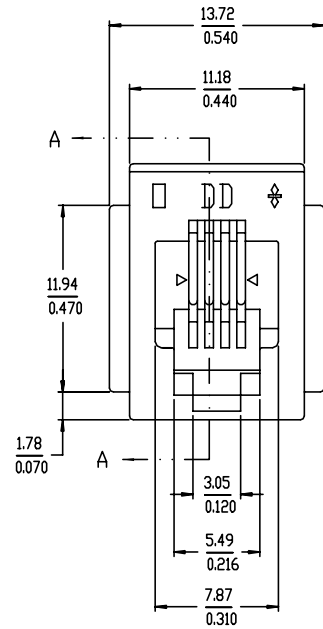
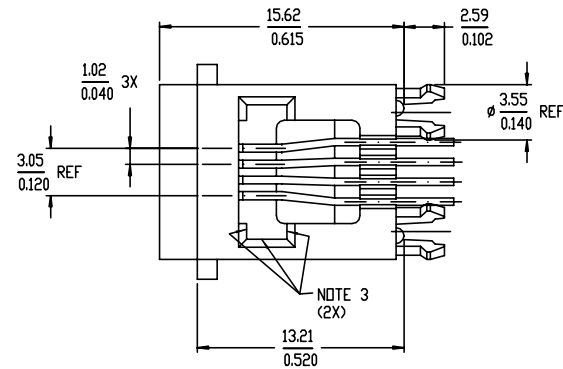
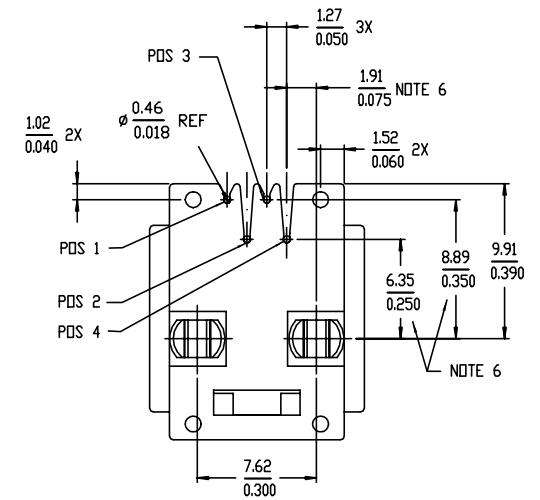


PRODUCT NO.
SEE CHART

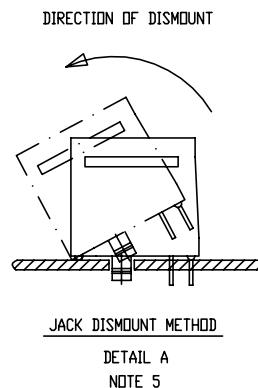
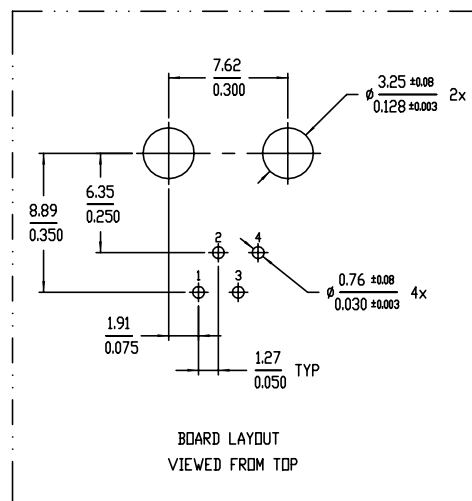
SECTION A-A



mat'l. code				surface		tolerance	projection	product family		
ISO1302				ISO1101		ISO406	mm	MOD JACK		
ltr ecn nodr				date		tolerances unless otherwise specified	mm	4 POS VERT. SNAP PEG		
K	S00022	LOW	01/25/00			0.X±0.3		PCB III MOD JACK ASSY		
L	N04-0102	YS	11/23/04			0.XX±0.15				
M	N08-0097	SH MMD	09/25/08			0.XXX±0.05	scale 2.0			
N	N08-0170	SH MMD	10/09/08	dr	M CHENG	7/13/01		dwg no		
P	ELX-N-010673	SH MMD	3/14/12	enr	M CHENG	7/13/01		sheet 1 of 2		
				chr	M CHENG	7/13/01		size		
				appd	J HSIA	7/20/01		A4		
sheet				revision		P		type		
index				sheet		1 2		Product Customer Drawing		

PRODUCT NO.	POSITIONS LOADED	CONTACT PLATING	NOTES
90511-001 -001LF -001HLF	ALL	5u" Au + high performance lubricant	BLACK
-002 -002LF -002HLF	ALL	5u" Au + high performance lubricant	BLACK
-003 -003LF	ALL	5u" Au + high performance lubricant	GREY
-004 -004LF	ALL	5u" Au + high performance lubricant	GREY
-005 -005LF -005HLF	ALL	50u" / 1.27u GXT	BLACK

LEAD FREE PRODUCT NO.
MEETS PIP PROCESS PRODUCT NO.



PRODUCT NO.	POSITIONS LOADED	CONTACT PLATING	REMARKS
90511-101 -101LF -101HLF	ALL	5u" Au + high performance lubricant	NOT TOOLED
-102 -102LF -102HLF	ALL	5u" Au + high performance lubricant	NOT TOOLED

NOTES :

- P/NO WITH DASH 0XX -NORMAL WAVE SOLDERING APPLICATION.
P/NO WITH DASH 1XX -IR REFLOW APPLICATION (NOT TOOLED).
- PACKAGING SPEC. BUS-14-164.
- SCRATCH MARKS ACCEPTABLE ON THESE SURFACES.
- JACK IS FOR 1,57//,062 THICK PCB.
- SHOULD THE JACK NEED TO BE DISMOUNTED FROM THE PCB, PLS REMOVE JACK AS PER RECOMMENDED METHOD HEREIN. (DETAIL A) NIPPING THE LEGS OF THE PEG TOGETHER IS DISALLOWED, OTHERWISE LEG BREAKAGE MAY OCCUR.
- THESE DIMENSIONS ARE TAKEN FROM THE TOP OF THE PEG.
- THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.60mm MINIMUM THICK CIRCUIT BOARD.
- IF LF P/N PACKAGING MEETS GS-14-920 SPECIFICATION.
- EQUIVALENT THICKNESS Au AND GXT PLATING HAVE SAME FUNCTION AND THEY ARE ALTERNATIVE BY THE CUSTDEMR .

mat'l. code	surface ISO1302	tolerance ISO1101 ISO406	projection ISO1101	product family MOD JACK
l t r e c n n o d r	date	tolerances unless otherwise specified	mm	title
K S00022 LOW 01/25/00	11/23/04	0.X±0.3	mm	4 POS VERT. SNAP PEG
L N04-0102 YS	09/25/08	0.XX±0.15	scale 2.0	PCB III MOD JACK ASSY
M N08-0097 SH MMD	10/09/08	0.XXX±0.05		
N N08-0170 SH MMD	3/14/12			
P ELX-N-010673 SH MMD				
sheet	revision			
index	sheet			